EMC Components

Chip beads For general signal line

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MMZ-HE series (for automotive)

AEC-Q200 MMZ1608-HE type

FEATURES

Noise reduction solution for general signal line.

○ The new terminal electrode design improves the bonding strength with solder and supports an environment of 150°C.

O High durability solder can be used.

○ Operating temperature range: -55 to +150°C

APPLICATION

Ovarious ECUs, powertrains and Electric brake booster

PART NUMBER CONSTRUCTION

MMZ	1608	S	HE	102	A	Т	D25
Series name	L×W×T dimensions 1.6×0.8×0.8 mm	Material name	Specifications (Grade)	Impedance (Ω) at 100MHz	Characteris- tic type	Packaging style	Internal code

CHARACTERISTICS SPECIFICATION TABLE

Impedance		DC resistance	Rated current		Part No.
[100MHz]			125°C	150°C	
(Ω)	Tolerance	(Ω)max.	(mA)max.	(mA)max.	
120	±25%	0.15	500	300	MMZ1608SHE121ATD25
470	±25%	0.3	500	250	MMZ1608SHE471ATD25
600	±25%	0.35	500	200	MMZ1608SHE601ATD25
1000	±25%	0.5	400	200	MMZ1608SHE102ATD25

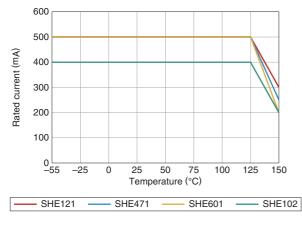
* Please refer to the graph of rated current vs. temperature characteristics (derating) about the rating current at 125°C or more in temperature of the product.

Measurement equipment

Measurement item	Product No.	Manufacturer	
Impedance	E4991A+16192A	Keysight Technologies	
DC resistance	Type-7556	Yokogawa	
* Equivalent measuren	nent equipment may be used		

Equivalent measurement equipment may be used.

Rated current vs. temperature characteristics (derating)



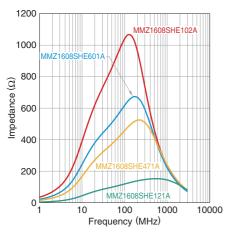
Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading. (1/4)

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MMZ1608-HE type

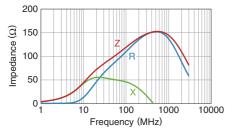
Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

MMZ1608SHE series

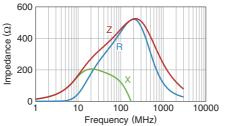


Z, X, R VS. FREQUENCY CHARACTERISTICS

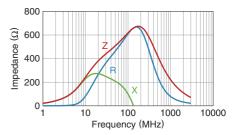
MMZ1608SHE121ATD25



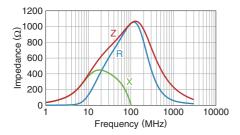
MMZ1608SHE471ATD25



MMZ1608SHE601ATD25



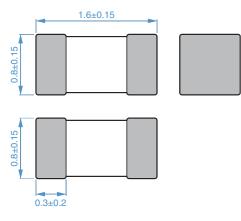
MMZ1608SHE102ATD25



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MMZ1608-HE type

SHAPE & DIMENSIONS



Dimensions in mm

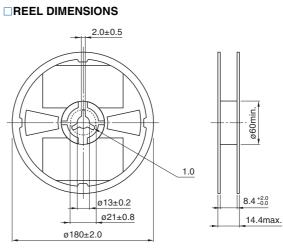
Soldering

Peak 250 to 260°C Natural

cooling

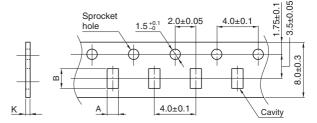
230°C

PACKAGING STYLE



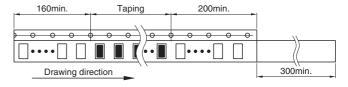
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	А	В	К
MMZ1608-HE	1.1±0.2	1.9±0.2	1.1max.



Dimensions in mm

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range	Storage temperature range*	Individual weight	
–55 to +150 °C	4 mg		
* The storage temperature range is for after the assembly			

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RECOMMENDED LAND PATTERN



Dimensions in mm

RECOMMENDED REFLOW PROFILE

Preheating

Temperature

150°C

PACKAGE QUANTITY 180°C Package quantity 4,000 pcs/reel 10s 60 to 120s 30 to 60s

Time

230°C

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REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

 The storage period is within 12 months. Be sure to follow the storage less). 					
If the storage period elapses, the soldering of the terminal electrode	-				
\supset Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).					
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature does not exceed 150°C. 	difference between the solder temperature and chip temperature				
 Soldering corrections after mounting should be within the range of the If overheated, a short circuit, performance deterioration, or lifespane 	-				
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.					
 Self heating (temperature increase) occurs when the power is turn design. 	Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.				
 Carefully lay out the coil for the circuit board design of the non-magr A malfunction may occur due to magnetic interference. 	netic shield type.				
\bigcirc Use a wrist band to discharge static electricity in your body through	the grounding wire.				
\bigcirc Do not expose the products to magnets or magnetic fields.					
\bigcirc Do not use for a purpose outside of the contents regulated in the definition of the content of	livery specifications.				
The products described in this catalog are intended to be installed in telecommunications equipment, home appliances, amusement equipment, measurement equipment, industrial robots) and to be used in a is mounted in a vehicle) or standard applications as general electron as general electronic equipment in automotive applications in accord while the said automotive or general electronic equipment including usage methods, respectively. Other than automotive or automotive p the applications listed below, whose performance and/or quality required malfunction or defect could cause serious damage to society, person	automobiles (including the case where the said automotive product nic equipment in automotive applications or standard applications lance with the scope and conditions described in this specification, the said product is intended to be used in the usual operation and roducts are not designed or warranted to meet the requirements of uires a more stringent level of safety or reliability, or whose failure,				
Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.					
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in this specification, please contact us.					
 (1) Aerospace/aviation equipment (2) Transportation equipment (electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment 	 (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications 				

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

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